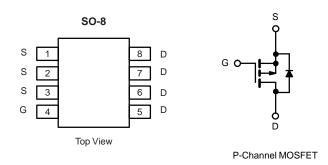


P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}$ (Ω) I_{D} (A)		Q _g (Typ.)		
	0.015 at V _{GS} = - 4.5 V	- 13 ^a			
- 20	0.021 at V _{GS} = - 2.5 V	- 10 ^a	20 nC		
	0.040 at V _{GS} = - 1.8 V	- 8			



FEATURES

- Halogen-free According to IEC 61249-2-21 . Definition
- TrenchFET[®] Power MOSFET
- •
- 100 % R_g Tested Built in ESD Protection with Zener Diode •
- Typical ESD Performance: 1800 V •
- Compliant to RoHS Directive 2002/95/EC •

APPLICATIONS

- Portable Devices
- Load Switch
- Battery Switch
- Charger Switch



RoHS COMPLIANT HALOGEN FREE

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 20	V		
Gate-Source Voltage	V _{GS}	± 12	v		
	T _C = 25 °C		- 13 ^a	A	
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		- 10 ^a		
Continuous Drain Current $(T_j = 150 \text{ C})$	T _A = 25 °C	I _D	- 8 ^{b, c}		
	T _A = 70 °C		- 7.1 ^{b, c}		
Pulsed Drain Current		I _{DM}	- 50		
Continuous Source-Drain Diode Current	T _C = 25 °C	L	- 6 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 2.9 ^{b, c}		
	T _C = 25 °C		19		
Maximum Power Dissipation	T _C = 70 °C	P _D	12	W	
	T _A = 25 °C	'D	3.5 ^{b, c}		
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperatur		260			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, e}	t ≤ 5 s	R _{thJA}	28	36	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5	0/11		

Notes:

a. Package limited.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. Maximum under Steady State conditions is 80 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 12		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.5		- 1.2	V	
	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$		± 20			
Gate-Source Leakage		$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 0.5	1.	
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	-	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 4.5 V	- 20			Α	
		V _{GS} = - 4.5 V, I _D = - 5.6 A		0.015		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 5.3 A		0.021			
		V _{GS} = - 1.8 V, I _D = - 2.5 A		0.040			
Forward Transconductance ^a	g _{fs}	V _{DS} = - 10 V, I _D = - 5.6 A		35		S	
Dynamic ^b	0.0						
Total Gate Charge		V _{DS} = - 10 V, V _{GS} = - 8 V, I _D = - 5 A		50	75		
Total Guto Chargo	Qg			20	30	-	
Gate-Source Charge	Q _{gs}	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_{D} = - 5 A		3.3			
Gate-Drain Charge	Q _{gd}			8.4			
Gate Resistance	R _g	f = 1 MHz	0.2	1	2	kΩ	
Turn-On Delay Time	t _{d(on)}		-	0.71	1.1		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{I}} = 1 \Omega$		1.7	2.6	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -5$ Å, $V_{GEN} = -4.5$ V, $R_g = 1$		6	9		
Fall Time		Ω		3.2	5		
Turn-On Delay Time	t _{d(on)}			0.3	0.45	us	
Rise Time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{I}} = 1 \Omega$		0.6	0.9		
Turn-Off Delay Time	t _{d(off)}	$I_{D} \cong -5 \text{ A}, V_{GEN} = -10 \text{ V}, \text{ R}_{g} = 1$		10	15		
Fall Time	t _f	Ω		3.5	5.5		
Drain-Source Body Diode Characterist							
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C		[- 6	[
Pulse Diode Forward Current	I _{SM}				- 50	A	
Body Diode Voltage	V _{SD}	I _S = - 5 A, V _{GS} = 0 V		- 0.85	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			30	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			20	40	nC	
Reverse Recovery Fall Time	t _a	$I_F = 6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		13	-	- ns	
Reverse Recovery Rise Time	t _b			10			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

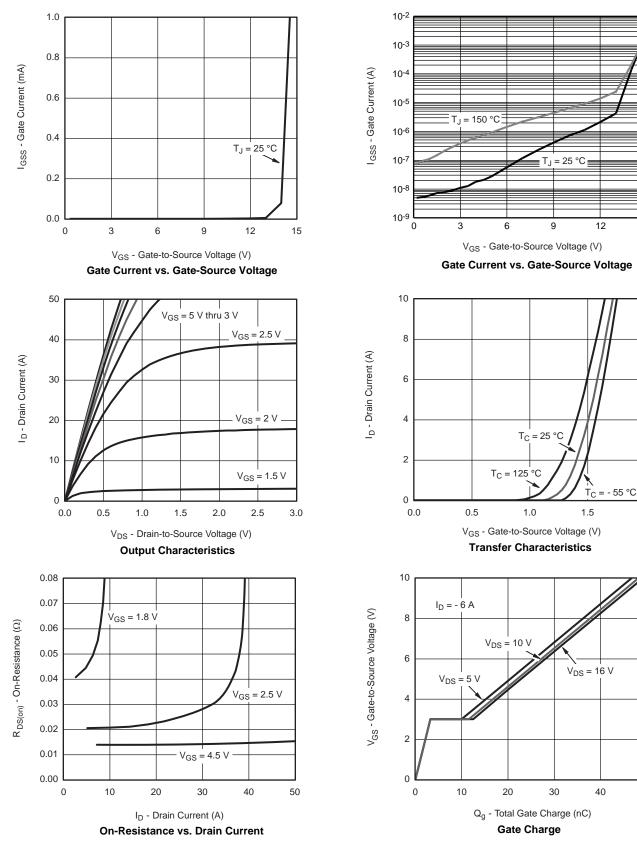
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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2.0

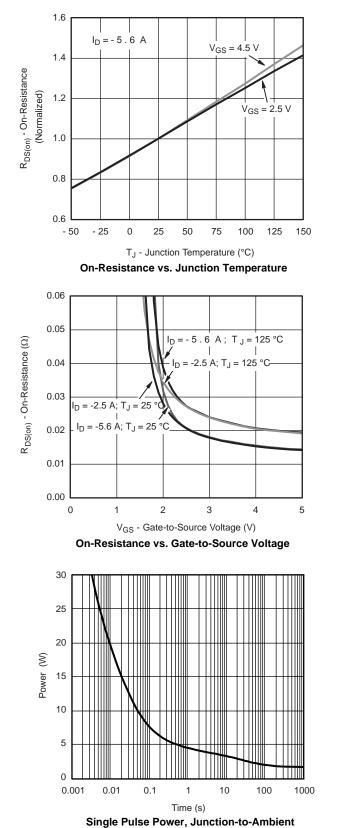
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

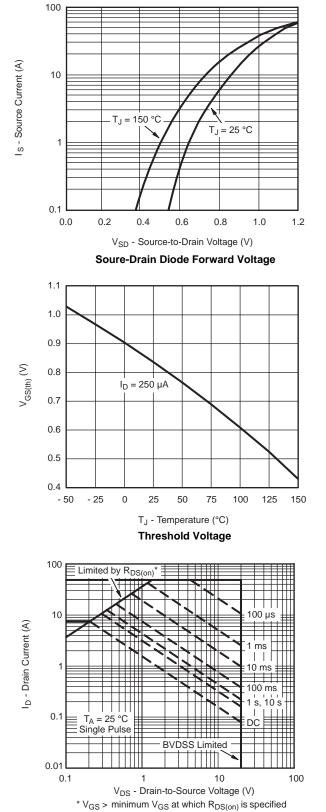


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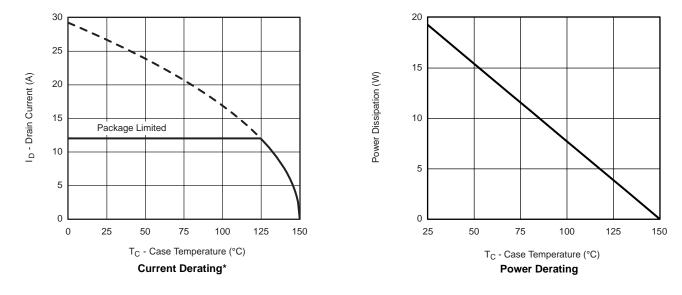
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Safe Operating Area, Junction-to-Ambient

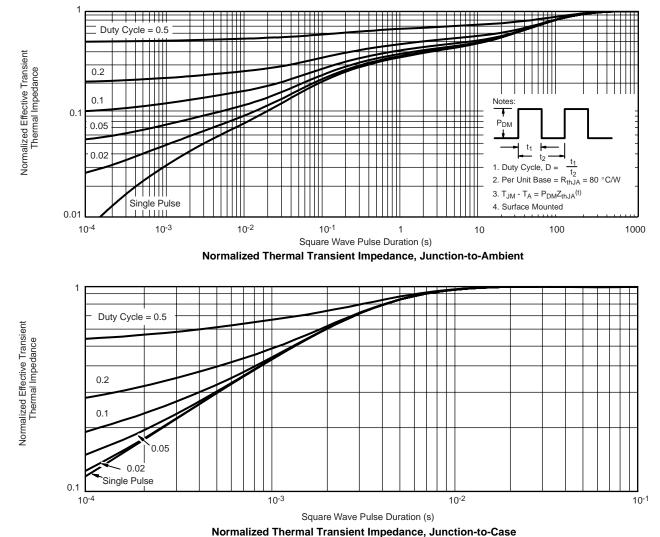




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

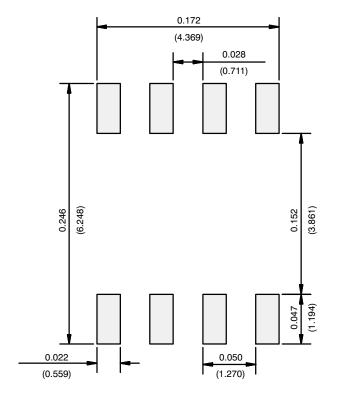




	MILLIMETERS		INC	HES		
DIM	Min	Max	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0.050 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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